

## Description

The AP2552/53 and AP2552A/53A are single channel precision adjustable current-limited switches optimized for applications that require precision current limiting, or to provide up to 2.1A of continuous load current during heavy loads/short circuits. These devices offer a programmable current-limit threshold between 75mA and 2.36A (Typ.) via an external resistor. Current limit accuracy  $\pm 6\%$  can be achieved at high current-limit settings. The rise and fall time are controlled to minimize current surges during turn on/off.

The devices have fast short-circuit response time for improved overall system robustness. They provide a complete protection solution for applications subject to heavy capacitive loads and the prospect of short circuit, offering reverse current blocking and limiting, over-current, over-temperature and short-circuit protection, as well as controlled rise time and under-voltage lockout functionality. A 7ms deglitch capability on the open-drain Flag output prevents false over-current reporting and does not require any external components.

AP2552/53 limits the output current to a safe level when the output current exceeds current-limit threshold.

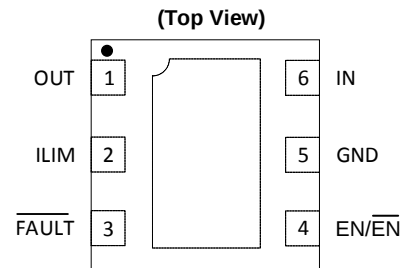
AP2552A/53A provides latch-off function during over-current or reverse-voltage conditions.

All devices are available in SOT26 and U-DFN2020-6 (Type C) packages.

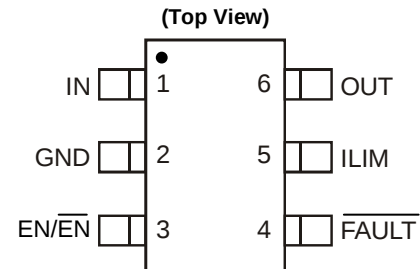
## Applications

- Set-Top Boxes
- LCD TVs & Monitors
- Residential Gateways
- Laptops, Desktops, Servers, e-Readers, Printers, Docking Stations, HUBs

## Pin Assignments



**U-DFN2020-6 (Type C)**



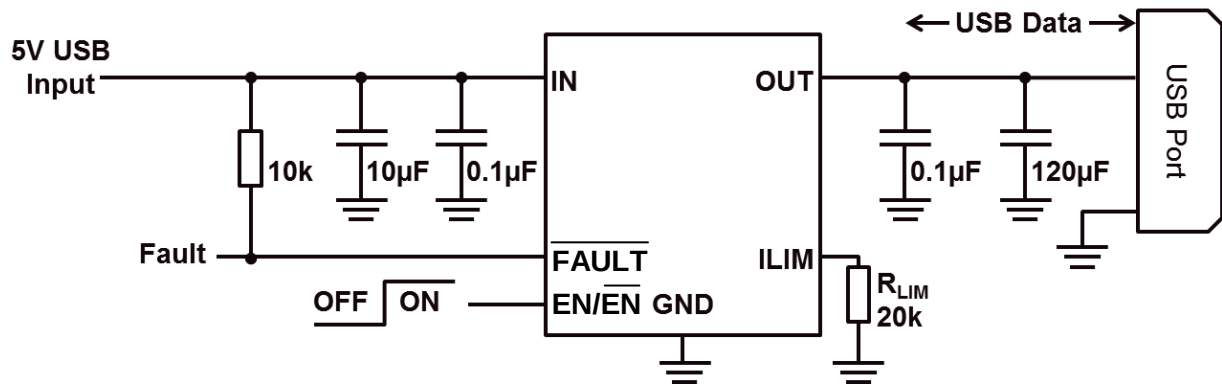
**SOT26**

## Features

- Up to 2.1A Maximum Load Current
- Accurate Adjustable Current Limit, 75mA to 2365mA
- $\pm 6\%$  Accurate Adjustable Current Limit, 1.632A with  $R_{LIM} = 15k\Omega$
- Constant-Current (AP2552/53) During Over-Current
- Output Latch-Off (AP2552A/53A) at Over-Current
- Fast Short-Circuit Response Time:  $2\mu s$  (Typ.)
- Reverse Current Blocking During Shutdown and Reverse Current Limiting During Enable
- Operating Range: 2.7V to 5.5V
- Built-in Soft-Start with 3ms Typical Rise Time
- Over-Current, Output Over-Voltage and Thermal Protection
- Fault Report (FAULT) with Blanking Time
- ESD Protection: 2kV HBM, 500V CDM
- Active Low (AP2552/52A) or Active High (AP2553/53A) Enable
- Ambient Temperature Range:  $-40^{\circ}C$  to  $+85^{\circ}C$
- SOT26 and U-DFN2020-6 (Type C) Packages: Available in "Green" Molding Compound (No Br, Sb)
- **Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)**
- **Halogen and Antimony Free. "Green" Device (Note 3)**
- 15kV ESD Protection per IEC 61000-4-2 (With External Capacitance)
- UL Recognized, File Number E322375, Vol. 1
- 1IEC60950-1 CB Scheme Certified

- Notes:
1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
  2. See <https://www.diodes.com/quality/lead-free/> for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
  3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

## Typical Applications Circuit (Note 4)



Note 4: 120µF output capacitance is a requirement of USB.

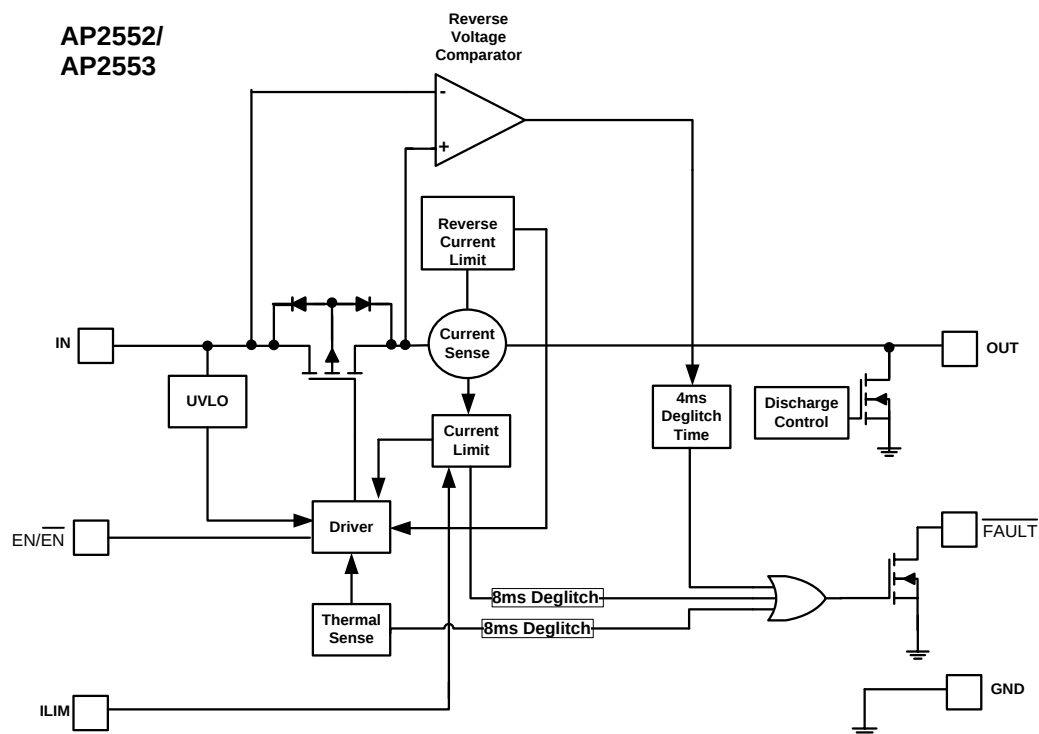
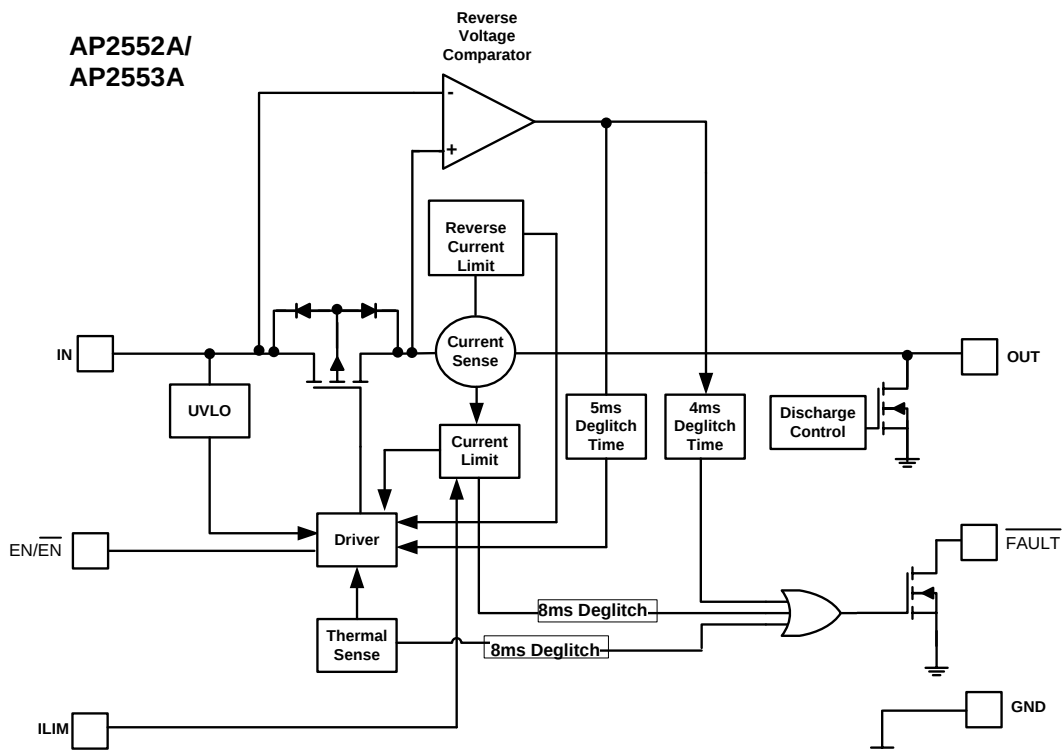
## Available Options

| Part Number | Channel | Enable Pin (EN/EN) | Recommended Maximum Continuous Load Current (A) | Current-Limit Protection | Package                       |
|-------------|---------|--------------------|-------------------------------------------------|--------------------------|-------------------------------|
| AP2552      | 1       | Active Low         | 2.1                                             | Constant-Current         | U-DFN2020-6 (Type C)<br>SOT26 |
| AP2553      | 1       | Active High        |                                                 |                          |                               |
| AP2552A     | 1       | Active Low         | 2.1                                             | Latch-Off                | U-DFN2020-6 (Type C)<br>SOT26 |
| AP2553A     | 1       | Active High        |                                                 |                          |                               |

## Pin Descriptions

| Pin Name                  | Pin Number         |                    |                      |                    | I/O | Function                                                                                                                                                   |
|---------------------------|--------------------|--------------------|----------------------|--------------------|-----|------------------------------------------------------------------------------------------------------------------------------------------------------------|
|                           | SOT26              |                    | U-DFN2020-6 (Type C) |                    |     |                                                                                                                                                            |
|                           | AP2552/<br>AP2552A | AP2553/<br>AP2553A | AP2552/<br>AP2552A   | AP2553/<br>AP2553A |     |                                                                                                                                                            |
| IN                        | 1                  | 1                  | 6                    | 6                  | I   | Input, connect a 0.1μF or greater ceramic capacitor from IN to GND as close to IC as possible.                                                             |
| GND                       | 2                  | 2                  | 5                    | 5                  | —   | Ground, connect to external exposed pad.                                                                                                                   |
| $\overline{\text{EN}}$    | 3                  | —                  | 4                    | —                  | I   | Enable input, logic low turns on power switch.                                                                                                             |
| EN                        | —                  | 3                  | —                    | 4                  | I   | Enable input, logic high turns on power switch.                                                                                                            |
| $\overline{\text{FAULT}}$ | 4                  | 4                  | 3                    | 3                  | O   | Active-low open-drain output, asserted during over-current, over-temperature, or reverse-voltage conditions.                                               |
| ILIM                      | 5                  | 5                  | 2                    | 2                  | O   | Use external resistor to set current-limit threshold; recommended $10\text{k}\Omega \leq R_{\text{LIM}} \leq 210\text{k}\Omega$ .                          |
| OUT                       | 6                  | 6                  | 1                    | 1                  | O   | Output                                                                                                                                                     |
| Exposed Pad               | —                  | —                  | Pad                  | Pad                | —   | No internal connection; recommend to connect to GND externally for improved power dissipation. It should not be used as electrical ground conduction path. |

## Functional Block Diagram



## Absolute Maximum Ratings (@T<sub>A</sub> = +25°C, unless otherwise specified.)

| Symbol                                                                                                             | Parameter                               | Ratings                                                                   | Unit |
|--------------------------------------------------------------------------------------------------------------------|-----------------------------------------|---------------------------------------------------------------------------|------|
| ESD                                                                                                                | HBM                                     | Human Body Model ESD Protection                                           | 2    |
|                                                                                                                    | CDM                                     | Charged Device Model ESD Protection                                       | 500  |
|                                                                                                                    | IEC System Level                        | Surges per IEC61000-4-2. 1999 Applied to Output Terminals of EVM (Note 6) | 15   |
| V <sub>IN</sub> , V <sub>OUT</sub> , V <sub>FAULT</sub> ,<br>V <sub>ILIM</sub> , V <sub>EN</sub> , V <sub>EN</sub> | Voltage on IN, OUT, FAULT, ILIM, EN, EN | -0.3 to +6.5                                                              | V    |
| —                                                                                                                  | Continuous FAULT Sink Current           | 25                                                                        | mA   |
| —                                                                                                                  | ILIM Source Current                     | 1                                                                         | mA   |
| I <sub>LOAD</sub>                                                                                                  | Maximum Continuous Load Current         | Internal Limited                                                          | A    |
| T <sub>J(MAX)</sub>                                                                                                | Maximum Junction Temperature            | -40 to +150                                                               | °C   |
| T <sub>STG</sub>                                                                                                   | Storage Temperature Range (Note 5)      | -65 to +150                                                               | °C   |

Notes: 5. UL Recognized Rating from -30°C to +70°C (Diodes Incorporated qualified T<sub>STG</sub> from -65°C to +150°C).  
6. External capacitors need to be connected to the output, EVM board was tested with capacitor 2.2μF 50V 0805. This level is a pass test only and not a limit.

Caution: Stresses greater than the 'Absolute Maximum Ratings' specified above, can cause permanent damage to the device. These are stress ratings only; functional operation of the device at these or any other conditions exceeding those indicated in this specification is not implied. Device reliability can be affected by exposure to absolute maximum rating conditions for extended periods of time.

Semiconductor devices are ESD sensitive and can be damaged by exposure to ESD events. Suitable ESD precautions should be taken when handling and transporting these devices.

## Dissipation Rating Table

| Board              | Package                 | Thermal Resistance<br>θ <sub>JA</sub> | Thermal Resistance<br>θ <sub>JC</sub> | T <sub>A</sub> ≤ +25°C<br>Power Rating | Derating Factor<br>Above<br>T <sub>A</sub> = +25°C | T <sub>A</sub> = +70°C<br>Power Rating | T <sub>A</sub> = +85°C<br>Power Rating |
|--------------------|-------------------------|---------------------------------------|---------------------------------------|----------------------------------------|----------------------------------------------------|----------------------------------------|----------------------------------------|
| High-K<br>(Note 7) | SOT26                   | 160°C/W                               | 55°C/W                                | 625mW                                  | 6.25mW/°C                                          | 340mW                                  | 250mW                                  |
| High-K<br>(Note 7) | U-DFN2020-6<br>(Type C) | 120°C/W                               | 34°C/W                                | 833mW                                  | 8.33mW/°C                                          | 450mW                                  | 330mW                                  |

Note: 7. The JEDEC high-K (2s2p) board used to derive this data was a 3inch × 3inch, multilayer board with 1oz internal power and ground planes with 2oz copper traces on top and bottom of the board.

## Recommended Operating Conditions (@T<sub>A</sub> = +25°C, unless otherwise specified.)

| Symbol                            | Parameter                                                        | Min | Max             | Unit |
|-----------------------------------|------------------------------------------------------------------|-----|-----------------|------|
| V <sub>IN</sub>                   | Input Voltage                                                    | 2.7 | 5.5             | V    |
| I <sub>OUT</sub>                  | Continuous Output Current (-40°C ≤ T <sub>A</sub> ≤ +85°C)       | 0   | 2.1             | A    |
| V <sub>EN</sub> , V <sub>EN</sub> | Enable Voltage                                                   | 0   | 5.5             | V    |
| V <sub>IH</sub>                   | High-Level Input Voltage on EN or EN                             | 2.0 | V <sub>IN</sub> | V    |
| V <sub>IL</sub>                   | Low-Level Input Voltage on EN or EN                              | 0   | 0.8             | V    |
| R <sub>LIM</sub>                  | Current-Limit Threshold Resistor Range<br>(1% Initial Tolerance) | 10  | 210             | kΩ   |
| I <sub>O</sub>                    | Continuous FAULT Sink Current                                    | 0   | 10              | mA   |
| —                                 | Input De-Coupling Capacitance, IN to GND                         | 0.1 | —               | μF   |
| T <sub>A</sub>                    | Operating Ambient Temperature                                    | -40 | +85             | °C   |
| T <sub>J</sub>                    | Operating Junction Temperature                                   | -40 | +125            | °C   |

**Electrical Characteristics** (@T<sub>A</sub> = +25°C, V<sub>IN</sub> = 2.7V to 5.5V, V<sub>EN</sub> = 0V or V<sub>EN</sub> = V<sub>IN</sub>, R<sub>FAULT</sub> = 10kΩ, unless otherwise specified.)

| Symbol                 | Parameter                                                                                           | Test Conditions (Note 8)                                                                               |                                                | Min  | Typ  | Max  | Unit |
|------------------------|-----------------------------------------------------------------------------------------------------|--------------------------------------------------------------------------------------------------------|------------------------------------------------|------|------|------|------|
| Supply                 |                                                                                                     |                                                                                                        |                                                |      |      |      |      |
| V <sub>UVLO</sub>      | Input UVLO                                                                                          | V <sub>IN</sub> Rising                                                                                 |                                                | —    | 2.4  | 2.65 | V    |
| ΔV <sub>UVLO</sub>     | Input UVLO Hysteresis                                                                               | V <sub>IN</sub> Decreasing                                                                             |                                                | —    | 25   | —    | mV   |
| I <sub>SHDN</sub>      | Input Shutdown Current                                                                              | V <sub>IN</sub> = 5.5V, Disabled, OUT = Open                                                           |                                                | —    | 0.1  | 1    | μA   |
| I <sub>Q</sub>         | Input Quiescent Current                                                                             | V <sub>IN</sub> = 5.5V, Enabled, OUT = Open, R <sub>LIM</sub> = 20kΩ                                   |                                                | —    | 100  | 140  | μA   |
|                        |                                                                                                     | V <sub>IN</sub> = 5.5V, Enabled, OUT = Open, R <sub>LIM</sub> = 210kΩ                                  |                                                | —    | 80   | 120  | μA   |
| I <sub>REV</sub>       | Reverse Leakage Current                                                                             | Disabled, V <sub>IN</sub> = 0V, V <sub>OUT</sub> = 5.5V, I <sub>REV</sub> at V <sub>IN</sub>           |                                                | —    | 0.01 | 1    | μA   |
| Power Switch           |                                                                                                     |                                                                                                        |                                                |      |      |      |      |
| R <sub>DS(ON)</sub>    | Switch On-Resistance                                                                                | SOT26 Package                                                                                          | T <sub>J</sub> = +25°C, V <sub>IN</sub> = 5.0V | —    | 70   | 95   | mΩ   |
|                        |                                                                                                     |                                                                                                        | -40°C ≤ T <sub>A</sub> ≤ +85°C                 | —    | —    | 135  |      |
|                        |                                                                                                     | U-DFN2020-6 (Type C) Package                                                                           | T <sub>J</sub> = +25°C, V <sub>IN</sub> = 5.0V | —    | 80   | 105  |      |
|                        |                                                                                                     |                                                                                                        | -40°C ≤ T <sub>A</sub> ≤ +85°C                 | —    | —    | 150  |      |
| t <sub>R</sub>         | Output Turn-On Rise Time                                                                            | V <sub>IN</sub> = 5.5V, C <sub>L</sub> = 1μF, R <sub>LOAD</sub> = 100Ω. See Figure 1                   |                                                | —    | 1.1  | 1.5  | ms   |
|                        |                                                                                                     | V <sub>IN</sub> = 2.7V, C <sub>L</sub> = 1μF, R <sub>LOAD</sub> = 100Ω.                                |                                                | —    | 0.7  | 1    | ms   |
| t <sub>F</sub>         | Output Turn-Off Fall Time                                                                           | V <sub>IN</sub> = 5.5V, C <sub>L</sub> = 1μF, R <sub>LOAD</sub> = 100Ω. See Figure 1                   |                                                | 0.1  | —    | 0.5  | ms   |
|                        |                                                                                                     | V <sub>IN</sub> = 2.7V, C <sub>L</sub> = 1μF, R <sub>LOAD</sub> = 100Ω.                                |                                                | 0.1  | —    | 0.5  | ms   |
| Current Limit          |                                                                                                     |                                                                                                        |                                                |      |      |      |      |
| I <sub>LIMIT</sub>     | Current-Limit Threshold<br>(Maximum DC Output Current),<br>V <sub>OUT</sub> = V <sub>IN</sub> -0.5V | R <sub>LIM</sub> = 10kΩ                                                                                | -40°C ≤ T <sub>A</sub> ≤ +85°C                 | 2200 | 2365 | 2542 | mA   |
|                        |                                                                                                     | R <sub>LIM</sub> = 15kΩ                                                                                | -40°C ≤ T <sub>A</sub> ≤ +85°C                 | 1540 | 1632 | 1730 |      |
|                        |                                                                                                     | R <sub>LIM</sub> = 20kΩ                                                                                | T <sub>J</sub> = +25°C                         | 1180 | 1251 | 1326 |      |
|                        |                                                                                                     |                                                                                                        | -40°C ≤ T <sub>A</sub> ≤ +85°C                 | 1160 | 1251 | 1340 |      |
|                        |                                                                                                     | R <sub>LIM</sub> = 49.9kΩ                                                                              | T <sub>J</sub> = +25°C                         | 500  | 530  | 562  |      |
|                        |                                                                                                     |                                                                                                        | -40°C ≤ T <sub>A</sub> ≤ +85°C                 | 485  | 529  | 573  |      |
|                        |                                                                                                     | R <sub>LIM</sub> = 210kΩ                                                                               |                                                | 121  | 142  | 162  |      |
| I <sub>SHORT</sub>     | Short-Circuit Current Limit, OUT<br>Connected to GND                                                | I <sub>LIM</sub> Shorted to IN or GND                                                                  |                                                | 50   | 75   | 100  | mA   |
|                        |                                                                                                     | R <sub>LIM</sub> = 10kΩ                                                                                |                                                | —    | 2620 | —    |      |
|                        |                                                                                                     | R <sub>LIM</sub> = 15kΩ                                                                                |                                                | —    | 1820 | —    |      |
|                        |                                                                                                     | R <sub>LIM</sub> = 20kΩ                                                                                |                                                | —    | 1380 | —    |      |
|                        |                                                                                                     | R <sub>LIM</sub> = 49.9kΩ                                                                              |                                                | —    | 570  | —    |      |
|                        |                                                                                                     | R <sub>LIM</sub> = 210kΩ                                                                               |                                                | —    | 150  | —    |      |
| t <sub>SHORT</sub>     | Short-Circuit Response Time                                                                         | V <sub>OUT</sub> = 0V to I <sub>OUT</sub> = I <sub>LIMIT</sub> (OUT shorted to ground)<br>See Figure 2 |                                                | —    | 2    | —    | μs   |
|                        |                                                                                                     |                                                                                                        |                                                |      |      |      |      |
| Enable Pin             |                                                                                                     |                                                                                                        |                                                |      |      |      |      |
| I <sub>LEAK-EN</sub>   | EN Input Leakage Current                                                                            | V <sub>IN</sub> = 5V, V <sub>EN</sub> = 0V and 6V                                                      |                                                | -0.5 | —    | 0.5  | μA   |
| t <sub>ON</sub>        | Turn-On Time                                                                                        | C <sub>L</sub> = 1μF, R <sub>L</sub> = 100Ω. See Figure 1                                              |                                                | —    | —    | 3    | ms   |
| t <sub>OFF</sub>       | Turn-Off Time                                                                                       | C <sub>L</sub> = 1μF, R <sub>L</sub> = 100Ω. See Figure 1                                              |                                                | —    | —    | 1    | ms   |
| Output Discharge       |                                                                                                     |                                                                                                        |                                                |      |      |      |      |
| R <sub>DIS</sub>       | Discharge Resistance (Note 9)                                                                       | V <sub>IN</sub> = 5V, Disabled, I <sub>OUT</sub> =1mA                                                  |                                                | —    | 600  | —    | Ω    |
| R <sub>DIS_LATCH</sub> | Discharge Resistance During<br>Latch-Off                                                            | V <sub>IN</sub> = 5V, Latch-Off, AP2552A/53A Only                                                      |                                                | —    | 1000 | —    | Ω    |

Notes: 8. Pulse-testing techniques maintain junction temperature close to ambient temperature; thermal effects must be taken into account separately.  
9. The discharge function is active when the device is disabled (when enable is de-asserted or during power-up power-down when V<sub>IN</sub> < V<sub>UVLO</sub>).  
The discharge function offers a resistive discharge path for the external storage capacitor for limited time.

**Electrical Characteristics** (continued) (@T<sub>A</sub> = +25°C, V<sub>IN</sub> = 2.7V to 5.5V, V<sub>EN</sub> = 0V or V<sub>EN</sub> = V<sub>IN</sub>, R<sub>FAULT</sub> = 10kΩ, unless otherwise specified.)

| Symbol                            | Parameter                                                                | Test Conditions (Note 8)                        | Min | Typ  | Max | Unit |
|-----------------------------------|--------------------------------------------------------------------------|-------------------------------------------------|-----|------|-----|------|
| <b>Reverse Voltage Protection</b> |                                                                          |                                                 |     |      |     |      |
| V <sub>RVP</sub>                  | Reverse-Voltage Comparator Trip Point                                    | V <sub>OUT</sub> – V <sub>IN</sub>              | 95  | 135  | 190 | mV   |
| I <sub>ROCP</sub>                 | Reverse Current Limit                                                    | V <sub>OUT</sub> – V <sub>IN</sub> = 200mV      | —   | 0.72 | —   | A    |
| t <sub>TRIG</sub>                 | Time from Reverse-Voltage Condition to MOSFET Turn Off (AP2552A/AP2553A) | V <sub>IN</sub> = 5V                            | 3   | 4.75 | 7   | ms   |
| <b>Fault Flag</b>                 |                                                                          |                                                 |     |      |     |      |
| V <sub>OL</sub>                   | FAULT Output Low Voltage                                                 | I <sub>FAULT</sub> = 1mA                        | —   | —    | 180 | mV   |
| I <sub>FOH</sub>                  | FAULT Off Current                                                        | V <sub>FAULT</sub> = 6V                         | —   | —    | 1   | μA   |
| t <sub>BLANK_OC</sub>             | FAULT Blanking and Latch Off Time (Over-Current)                         | Assertion or deassertion due to overcurrent     | 5   | 7.5  | 10  | ms   |
| t <sub>BLANK_RV</sub>             | FAULT Blanking Time (Reverse-Voltage)                                    | Assertion or deassertion due to reverse-voltage | 2   | 3.75 | 6   | ms   |
| <b>Thermal Shutdown</b>           |                                                                          |                                                 |     |      |     |      |
| T <sub>SHDN</sub>                 | Thermal Shutdown Threshold                                               | Enabled, R <sub>LOAD</sub> = 1kΩ                | —   | +160 | —   | °C   |
| T <sub>SHDN_OCP</sub>             | Thermal Shutdown Threshold under Current Limit                           | Enabled, R <sub>LOAD</sub> = 1kΩ                | —   | +140 | —   | °C   |
| T <sub>HYS</sub>                  | Thermal Shutdown Hysteresis                                              | —                                               | —   | +20  | —   | °C   |

**Typical Performance Characteristics**

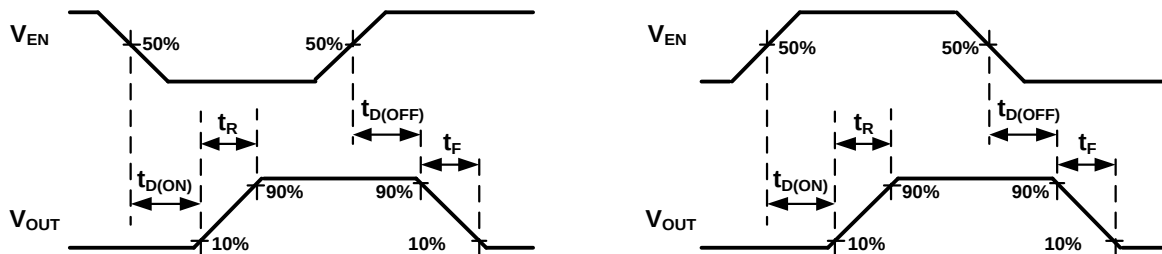


Figure 1. Voltage Waveforms: AP2552/52A (Left), AP2553/53A (Right)

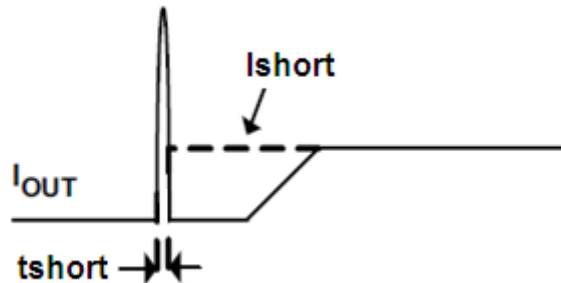


Figure 2. Response Time to Short Circuit Waveform

## Typical Performance Characteristics (continued)

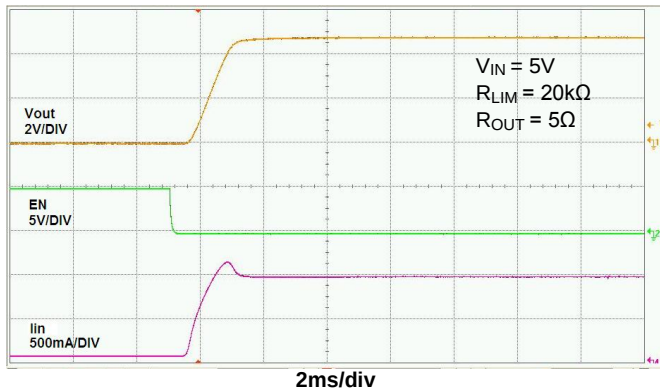


Figure 3. Turn-On Delay and Rise Time

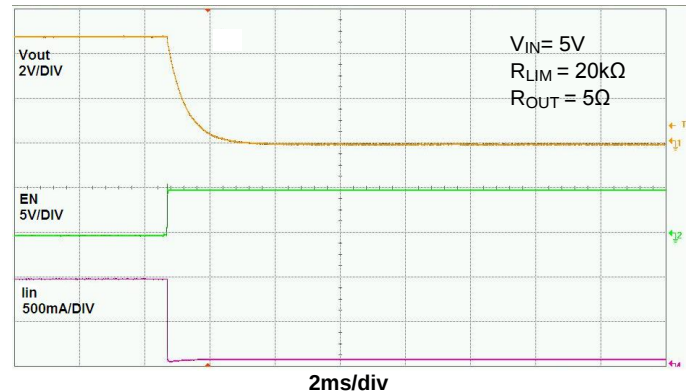


Figure 4. Turn-Off Delay and Fall Time

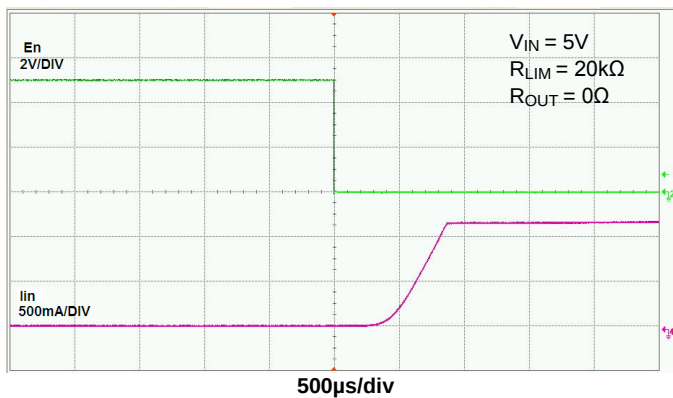


Figure 5. Device Enabled into Short-Circuit

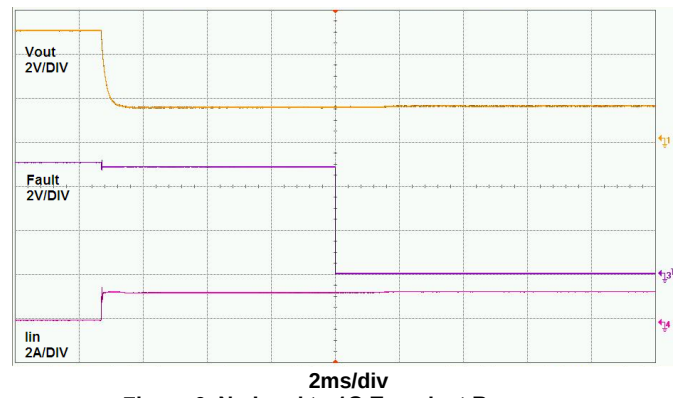


Figure 6. No Load to 1Ω Transient Response

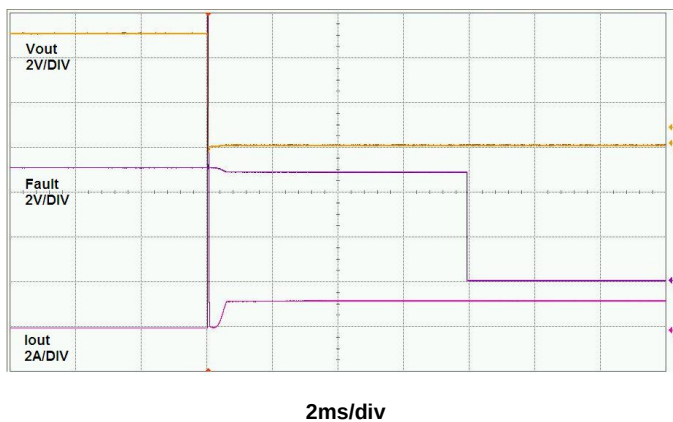


Figure 7. Short-Circuit Current Limit Response

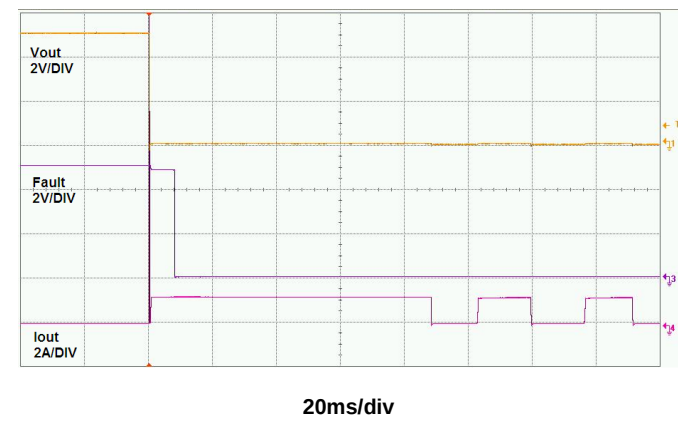


Figure 8. Extended Short-Circuit into Thermal Cycles

## Typical Performance Characteristics (continued)

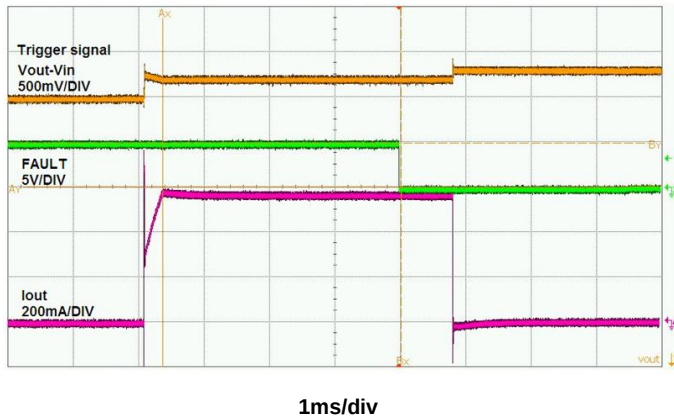


Figure 9. Reverse Current Limit Response (AP2552A/AP2553A)

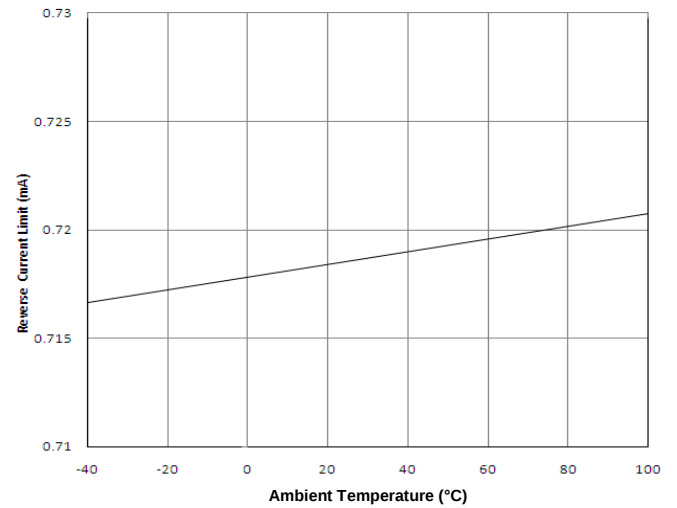


Figure 10. Reverse Current Limit vs. Ambient Temperature

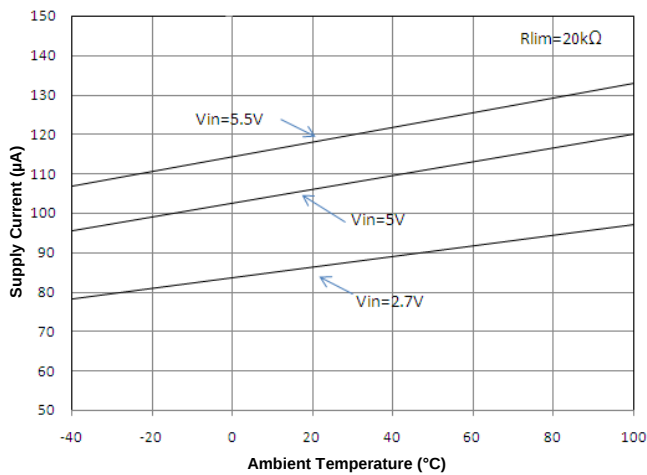


Figure 11. Quiescent Supply Current vs. Ambient Temperature

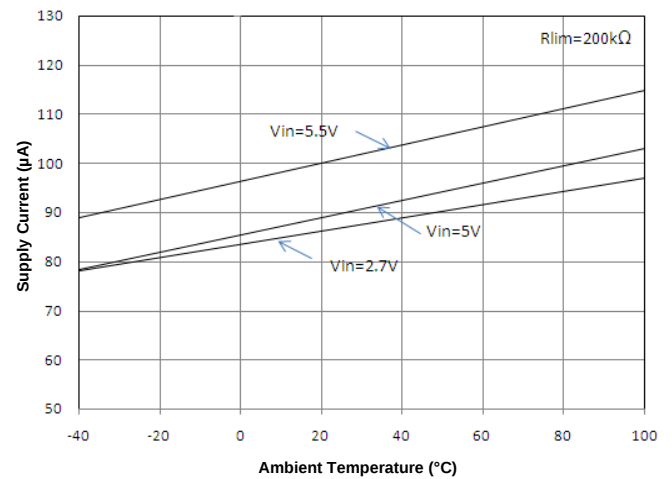


Figure 12. Quiescent Supply Current vs. Ambient Temperature

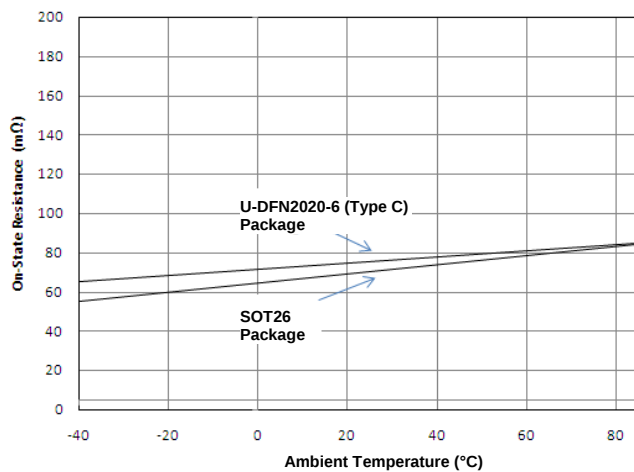


Figure 13. Switch On-Resistance vs. Ambient Temperature

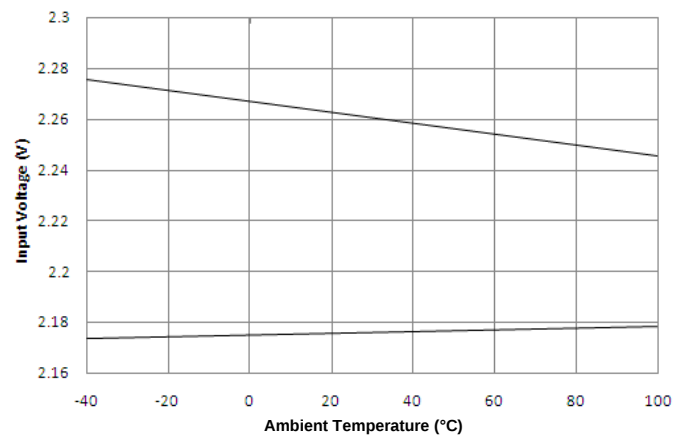


Figure 14. Under-Voltage Lock Out vs. Ambient Temperature

## Application Information

The AP2552/53 and AP2552A/53A are integrated high-side power switches optimized for Universal Serial Bus (USB) that require protection functions. The power switches are equipped with a driver that controls the gate voltage and incorporates slew-rate limitation. This, along with the various protection features and special functions, makes these power switches ideal for hot-swap or hot-plug applications.

### Protection Features

#### Under-Voltage Lockout (UVLO)

Whenever the input voltage falls below UVLO threshold (~2.5V), the power switch is turned off. This facilitates the design of hot-insertion systems where it is not possible to turn off the power switch before input power is removed.

#### Over-Current and Short-Circuit Protection

An internal sensing FET is employed to check for over-current conditions. Unlike current-sense resistors, sense FETs do not increase the series resistance of the current path. When an overcurrent condition is detected, AP2552/53 maintains a constant output current and reduces the output voltage accordingly. Complete shutdown occurs only if the fault stays long enough to activate thermal limiting.

For AP2552A/53A, when an overcurrent condition is detected, the devices will limit the current until the overload condition is removed or the internal deglitch time (7ms typical) is reached, and AP2552A/53A will be turned off. AP2552A/53A will remain latched off until power is cycled or the device enable is toggled.

The different overload conditions and the corresponding response of the AP2552/53 and AP2552A/53A are outlined below:

| NO | Conditions                                                     | Explanation                                                                     | Behavior of the AP2552/53                                                                                                                                                                                                                                                                                                                                                                                     |
|----|----------------------------------------------------------------|---------------------------------------------------------------------------------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 1  | Short-circuit condition at start-up                            | Output is shorted before input voltage is applied or before the part is enabled | The IC senses the short circuit and immediately clamps output current to a certain safe level namely $I_{SHORT}$ .                                                                                                                                                                                                                                                                                            |
| 2  | Short-circuit or overcurrent condition                         | Short-Circuit or Overload condition that occurs when the part is enabled.       | <ul style="list-style-type: none"> <li>At the instance the overload occurs, higher current may flow for a very short period of time before the current limit function can react.</li> <li>After the current limit function has tripped (reached the over-current trip threshold), the device switches into current limiting mode and the current is clamped at <math>I_{SHORT} / I_{LIMIT}</math>.</li> </ul> |
| 3  | Gradual increase from nominal operating current to $I_{LIMIT}$ | Load increases gradually until the current-limit threshold. ( $I_{TRIG}$ )      | The current rises until $I_{LIMIT}$ or thermal limit. Once the threshold has been reached, the device switches into its current limiting mode and is set at $I_{LIMIT}$ .                                                                                                                                                                                                                                     |

| NO | Conditions                                                     | Explanation                                                                     | Behavior of the AP2552A/53A                                                                                                                                                                                                                                                                                                                                                                                                                                                                                |
|----|----------------------------------------------------------------|---------------------------------------------------------------------------------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 1  | Short-circuit condition at start-up                            | Output is shorted before input voltage is applied or before the part is enabled | The IC senses the short circuit and immediately clamps output current to a certain safe level namely $I_{SHORT}$ . When the internal deglitch time (7ms typical) is reached and the devices will be turned off.                                                                                                                                                                                                                                                                                            |
| 2  | Short-circuit or overcurrent condition                         | Short-Circuit or Overload condition that occurs when the part is enabled.       | <ul style="list-style-type: none"> <li>At the instance the overload occurs, higher current may flow for a very short period of time before the current limit function can react.</li> <li>After the current limit function has tripped (reached the over-current trip threshold), the device switches into current limiting mode and the current is clamped at <math>I_{SHORT} / I_{LIMIT}</math>. When the internal deglitch time (7ms typical) is reached and the devices will be turned off.</li> </ul> |
| 3  | Gradual increase from nominal operating current to $I_{LIMIT}$ | Load increases gradually until the current-limit threshold. ( $I_{TRIG}$ )      | The current rises until $I_{LIMIT}$ or thermal limit. Once the threshold has been reached, the device switches into its current limiting mode and is set at $I_{LIMIT}$ . When the internal deglitch time (7ms typical) is reached and the devices will be turned off.                                                                                                                                                                                                                                     |

#### Over-Current FAULT Signal

The FAULT signal could be asserted in response to OCP before the device reaches its current limit. The output current upon FAULT signal triggered will be lower than the  $I_{limit}$  value. To implement FAULT signal for precision system protection control, it is recommended to leave enough margin from maximum continuous operating current for each  $R_{LIM}$  value condition. For latch-off version, when over current is detected, device current will be clamped and device will latch off once FAULT signal asserted. To implement FAULT signal for precision system protection control, leave enough margin from maximum continuous operating current is highly recommended. Please consult Diodes Incorporated representative about margin recommendation for each  $R_{LIM}$  value condition.

## Application Information (continued)

### Current-Limit Threshold Programming

The current-limit threshold can be programmed using an external resistor. The current-limit threshold is proportional to the current sourced out of  $I_{LIM}$ .

The recommended 1% resistor range for  $R_{LIM}$  is  $10k\Omega \leq R_{LIM} \leq 210k\Omega$ . Figure 15 includes current-limit tolerance due to variations caused by temperature and process. This graph does not include the external resistor tolerance. The traces routing the  $R_{LIM}$  resistor to the AP2552/53 and AP2552A/53A should be as short as possible to reduce parasitic effects on the current-limit accuracy.

To design below a maximum current-limit threshold, find the intersection of  $R_{LIM}$  and the maximum desired load current on the  $I_{OS(MAX)}$  ( $I_{LIM}$ ) curve and choose a value of  $R_{LIM}$  above this value. Programming the current limit below a maximum threshold is important to avoid current limiting upstream power supplies causing the input voltage bus to droop. The resulting minimum current-limit threshold is the intersection of the selected value of  $R_{LIM}$  and the  $I_{OS(MIN)}$  ( $I_{LIM}$ ) curve.

Best Fit Current-Limit Threshold Equations ( $I_{LIMIT}$ ):

$$I_{LIM(MAX)}(mA) = \frac{20.08}{R_{LIM}^{0.904} k\Omega}$$

$$I_{LIM(TYP)}(mA) = \frac{19.94}{R_{LIM}^{0.925} k\Omega}$$

$$I_{LIM(MIN)}(mA) = \frac{20.26}{R_{LIM}^{0.956} k\Omega}$$

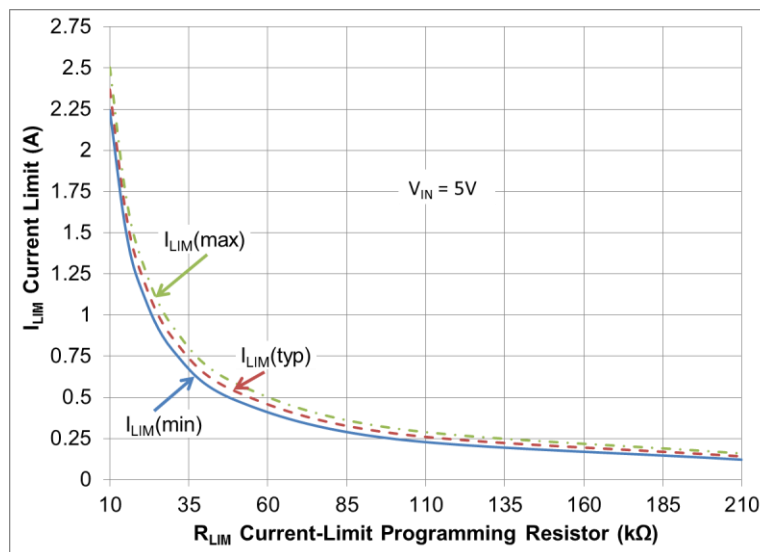


Figure 15. Current-Limit Threshold vs.  $R_{LIM}$

### Thermal Protection

Thermal protection prevents the IC from damage when the die temperature exceeds safe margins. This mainly occurs when heavy-overload or short-circuit faults are present for extended periods of time. The AP2552/53 and AP2552A/53A implements a thermal sensing to monitor the operating junction temperature of the power distribution switch. Once the die temperature rises to approximately  $+160^{\circ}\text{C}$  ( $+140^{\circ}\text{C}$  in case the part is under current limit), the thermal protection feature activates as follows: The internal thermal sense circuitry turns the power switch off and the FAULT output is asserted, thus preventing the power switch from damage. Hysteresis in the thermal sense circuit allows the device to cool down by approximately  $+20^{\circ}\text{C}$  before the output is turned back on. This built-in thermal hysteresis feature is an excellent feature, as it avoids undesirable oscillations of the thermal protection circuit. The switch continues to cycle in this manner until the load fault is removed, resulting in a pulsed output.

## Application Information (continued)

### Reverse-Current and Reverse-Voltage Protection

The USB specification does not allow an output device to source current back into the USB port. In a normal MOSFET switch, current will flow in reverse direction (from the output side to the input side) when the output side voltage is higher than the input side. A reverse-current limit (ROCP) feature is implemented in the AP2552/53 and AP2552A/53A to limit such back currents. The ROCP circuit is activated when the output voltage is higher than the input voltage. After the reverse current circuit has tripped (reached the reverse current trip threshold), the current is clamped at this IROCP level.

In addition to ROCP, reverse over-voltage protection (ROVP) is also implemented. The ROVP circuit is activated by the reverse voltage comparator trip point; i.e., the difference between the output voltage and the input voltage.

For AP2552/53, once ROVP is activated, FAULT assertion occurs at a de-glitch time of 4ms. Recovery from ROVP is automatic when the fault is removed. FAULT de-assertion de-glitch time is same as the de-assertion time.

For AP2552A/53A, once ROVP is activated and when the condition exists for more than 5ms (Typ.), output device is disabled and shut down. This is called the "Time from Reverse-Voltage Condition to MOSFET Turn Off". FAULT assertion occurs at a de-glitch time of 4ms after ROVP is reached. Recovery from this fault is achieved by recycling power or toggling EN. FAULT de-assertion de-glitch time is same as the de-assertion time.

## Special Functions

### Discharge Function

When enable is de-asserted, or when the input voltage is under UVLO level, the discharge function is active. The output capacitor is discharged through an internal NMOS that has a discharge resistance of 100Ω. Hence, the output voltage drops down to zero. The time taken for discharge is dependent on the RC time constant of the resistance and the output capacitor.

### FAULT Response

The FAULT open-drain output goes active low for any of following faults: Current limit threshold, short-circuit current limit, reverse-voltage condition or thermal shutdown. The time from when a fault condition is encountered to when the FAULT output goes low is 7ms (Typ.). The FAULT output remains low until over-current, short-circuit current limit and over-temperature conditions are removed. Connecting a heavy capacitive load to the output of the device can cause a momentary over-current condition, which does not trigger the FAULT due to the 7ms de-glitch timeout. This 7ms timeout is also applicable for over-current recovery and over-temperature recovery. The AP2552/53 and AP2552A/53A are designed to eliminate erroneous over-current reporting without the need for external components, such as an RC delay network.

For the AP2552/53 and AP2552A/53A when the reverse voltage condition is triggered, FAULT output goes low after 4ms (Typ.). This 4ms (Typ.) timeout is also applicable for the recovery from reverse voltage fault.

When the ILIM pin is shorted to IN or GND, current-limit threshold and short-circuit current limit will be clamped at typically 75mA. When the ILIM pin is shorted to IN or GND, the AP2552/53 and AP2552A/53A FAULT pin will not assert during current limiting conditions; The FAULT pin will assert during short circuit conditions.

For latch-off version, once Fault signal is triggered, device will stay off until EN pin is toggled or power is restarted.

### Power Supply Considerations

A 0.01μF to 0.1μF X7R or X5R ceramic bypass capacitor between IN and GND, close to the device, is recommended. This limits the input voltage drop during line transients. Placing a high-value electrolytic capacitor on the input (10μF minimum) and output pin (120μF) is recommended when the output load is heavy. This precaution also reduces power-supply transients that may cause ringing on the input. Additionally, bypassing the device output with a 0.1μF to 4.7μF ceramic capacitor improves the immunity of the device to short-circuit transients. This capacitor also prevents output from going negative during turn-off due to parasitic inductance.

### Power Dissipation and Junction Temperature

The low on-resistance of the internal MOSFET allows the small surface-mount packages to pass large current. Using the maximum operating ambient temperature ( $T_A$ ) and  $R_{DS(ON)}$ , the power dissipation can be calculated by:

$$P_D = R_{DS(ON)} \times I^2$$

Finally, calculate the junction temperature:

$$T_J = P_D \times \theta_{JA} + T_A$$

Where:

$T_A$  = Ambient temperature °C

$\theta_{JA}$  = Thermal resistance

$P_D$  = Total power dissipation

## Application Information (continued)

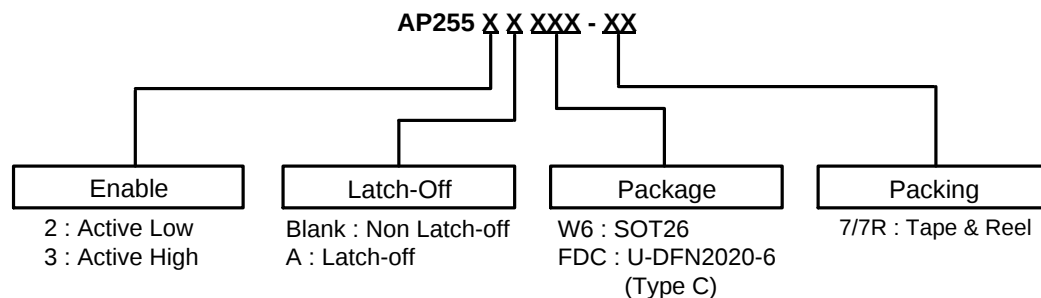
### Generic Hot-Plug Applications

In many applications it may be necessary to remove modules or PC boards while the main unit is still operating. These are considered hot-plug applications. Such implementations require the control of current surges seen by the main power supply and the card being inserted. The most effective way to control these surges is to limit and slowly ramp the current and voltage being applied to the card, similar to the way in which a power supply normally turns on. Due to the controlled rise and fall time of the AP2552/53 and AP2552A/53A, these devices can be used to provide a softer start-up to devices being hot-plugged into a powered system. The UVLO feature of the AP2552/53 and AP2552A/53A also ensures that the switch is off after the card has been removed, and that the switch is off during the next insertion.

### Generic Hot-Plug Applications

By placing the AP2552/53 and AP2552A/53A between the  $V_{CC}$  input and the rest of the circuitry, the input power reaches these devices first after insertion. The typical rise time of the switch is approximately 1ms, providing a slow voltage ramp at the output of the device. This implementation controls system surge current and provides a hot-plugging mechanism for any device.

## Ordering Information

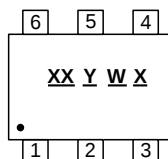


| Part Number   | Enable Active | Output Fault Condition | Package Code | Packaging            | 7" Tape and Reel |                    |
|---------------|---------------|------------------------|--------------|----------------------|------------------|--------------------|
|               |               |                        |              |                      | Quantity         | Part Number Suffix |
| AP2552W6-7    | Low           | Output Current Limits  | W6           | SOT26                | 3000/Tape & Reel | -7                 |
| AP2552FDC-7   |               |                        | FDC          | U-DFN2020-6 (Type C) | 3000/Tape & Reel | -7                 |
| AP2552FDC-7R  |               |                        | FDC          | U-DFN2020-6 (Type C) | 3000/Tape & Reel | -7R                |
| AP2553W6-7    | High          |                        | W6           | SOT26                | 3000/Tape & Reel | -7                 |
| AP2553FDC-7   |               |                        | FDC          | U-DFN2020-6 (Type C) | 3000/Tape & Reel | -7                 |
| AP2553FDC-7R  |               |                        | FDC          | U-DFN2020-6 (Type C) | 3000/Tape & Reel | -7R                |
| AP2552AW6-7   | Low           | Output Latches Off     | W6           | SOT26                | 3000/Tape & Reel | -7                 |
| AP2552AFDC-7  |               |                        | FDC          | U-DFN2020-6 (Type C) | 3000/Tape & Reel | -7                 |
| AP2552AFDC-7R |               |                        | FDC          | U-DFN2020-6 (Type C) | 3000/Tape & Reel | -7R                |
| AP2553AW6-7   | High          |                        | W6           | SOT26                | 3000/Tape & Reel | -7                 |
| AP2553AFDC-7  |               |                        | FDC          | U-DFN2020-6 (Type C) | 3000/Tape & Reel | -7                 |
| AP2553AFDC-7R |               |                        | FDC          | U-DFN2020-6 (Type C) | 3000/Tape & Reel | -7R                |

## Marking Information

### (1) SOT26

(Top View)



XX : Identification Code

Y : Year 0~9

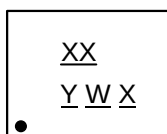
W : Week : A~Z : 1~26 week;  
a~z : 27~52 week; z represents  
52 and 53 week

X : Internal Code

| Part Number | Package | Identification Code |
|-------------|---------|---------------------|
| AP2552W6-7  | SOT26   | BJ                  |
| AP2553W6-7  | SOT26   | BK                  |
| AP2552AW6-7 | SOT26   | BM                  |
| AP2553AW6-7 | SOT26   | BN                  |

### (2) U-DFN2020-6 (Type C)

(Top View)



XX : Identification Code

Y : Year : 0~9

W : Week : A~Z : 1~26 week;  
a~z : 27~52 week; z represents  
52 and 53 week

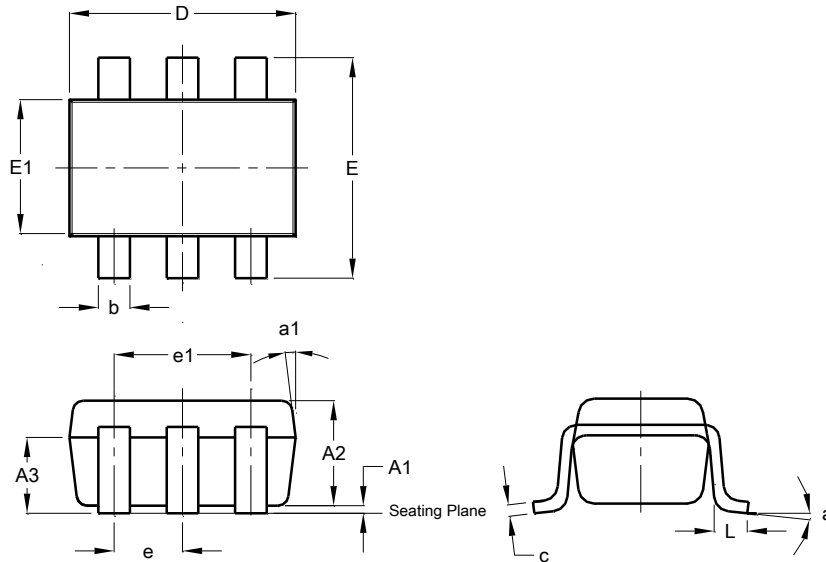
X : Internal Code

| Part Number   | Package              | Identification Code |
|---------------|----------------------|---------------------|
| AP2552FDC-7   | U-DFN2020-6 (Type C) | BJ                  |
| AP2552FDC-7R  | U-DFN2020-6 (Type C) | BJ                  |
| AP2553FDC-7   | U-DFN2020-6 (Type C) | BK                  |
| AP2553FDC-7R  | U-DFN2020-6 (Type C) | BK                  |
| AP2552AFDC-7  | U-DFN2020-6 (Type C) | BM                  |
| AP2552AFDC-7R | U-DFN2020-6 (Type C) | BM                  |
| AP2553AFDC-7  | U-DFN2020-6 (Type C) | BN                  |
| AP2553AFDC-7R | U-DFN2020-6 (Type C) | BN                  |

## Package Outline Dimensions

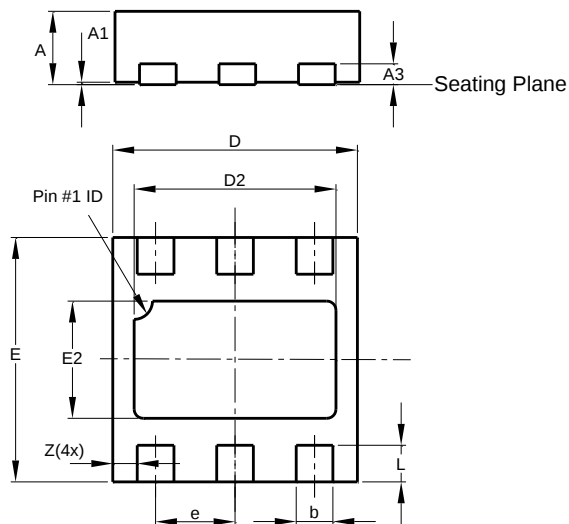
Please see <http://www.diodes.com/package-outlines.html> for the latest version.

### (1) Package Type: SOT26



| SOT26                |       |      |      |
|----------------------|-------|------|------|
| Dim                  | Min   | Max  | Typ  |
| A1                   | 0.013 | 0.10 | 0.05 |
| A2                   | 1.00  | 1.30 | 1.10 |
| A3                   | 0.70  | 0.80 | 0.75 |
| b                    | 0.35  | 0.50 | 0.38 |
| c                    | 0.10  | 0.20 | 0.15 |
| D                    | 2.90  | 3.10 | 3.00 |
| e                    | —     | —    | 0.95 |
| e1                   | —     | —    | 1.90 |
| E                    | 2.70  | 3.00 | 2.80 |
| E1                   | 1.50  | 1.70 | 1.60 |
| L                    | 0.35  | 0.55 | 0.40 |
| a                    | —     | —    | 8°   |
| a1                   | —     | —    | 7°   |
| All Dimensions in mm |       |      |      |

### (2) Package Type: U-DFN2020-6 (Type C)

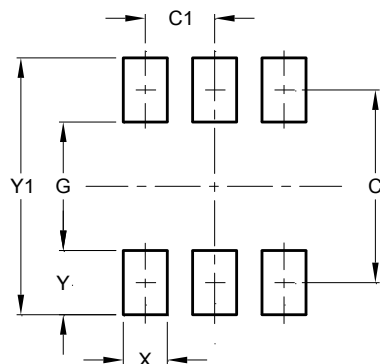


| U-DFN2020-6<br>Type C |      |       |      |
|-----------------------|------|-------|------|
| Dim                   | Min  | Max   | Typ  |
| A                     | 0.57 | 0.63  | 0.60 |
| A1                    | 0.00 | 0.05  | 0.02 |
| A3                    | —    | —     | 0.15 |
| b                     | 0.25 | 0.35  | 0.30 |
| D                     | 1.95 | 2.075 | 2.00 |
| D2                    | 1.55 | 1.75  | 1.65 |
| E                     | 1.95 | 2.075 | 2.00 |
| E2                    | 0.86 | 1.06  | 0.96 |
| e                     | —    | —     | 0.65 |
| L                     | 0.25 | 0.35  | 0.30 |
| Z                     | —    | —     | 0.20 |
| All Dimensions in mm  |      |       |      |

## Suggested Pad Layout

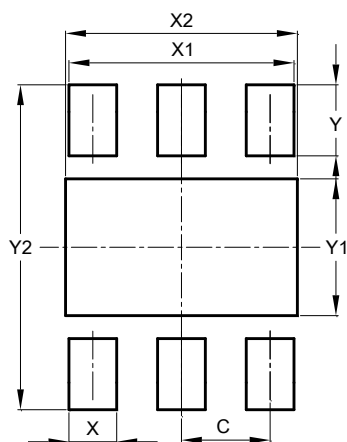
Please see <http://www.diodes.com/package-outlines.html> for the latest version.

### (1) Package Type: SOT26



| Dimensions | Value (in mm) |
|------------|---------------|
| C          | 2.40          |
| C1         | 0.95          |
| G          | 1.60          |
| X          | 0.55          |
| Y          | 0.80          |
| Y1         | 3.20          |

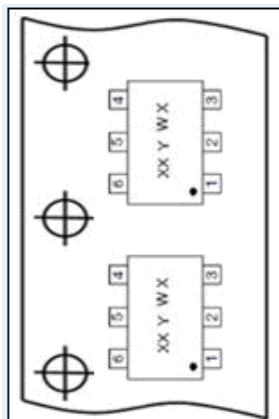
### (2) Package Type: U-DFN2020-6 (Type C)



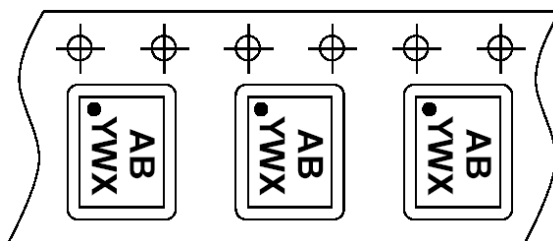
| Dimensions | Value (in mm) |
|------------|---------------|
| C          | 0.650         |
| X          | 0.350         |
| X1         | 1.650         |
| X2         | 1.700         |
| Y          | 0.525         |
| Y1         | 1.010         |
| Y2         | 2.400         |

## Taping Orientation (Note 10)

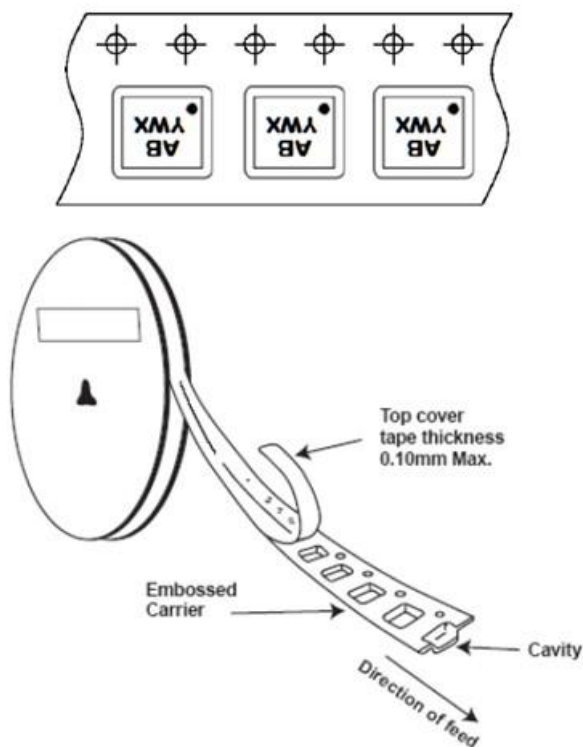
### (1) Package Type: SOT26



### (2) Package Type (-7) : U-DFN2020-6 (Type C)



### (3) Package Type (-7R) : U-DFN2020-6 (Type C)



Note: 10. The taping orientation of the other package type can be found on our website at <https://www.diodes.com/assets/Packaging-Support-Docs/Ap02007.pdf>.

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